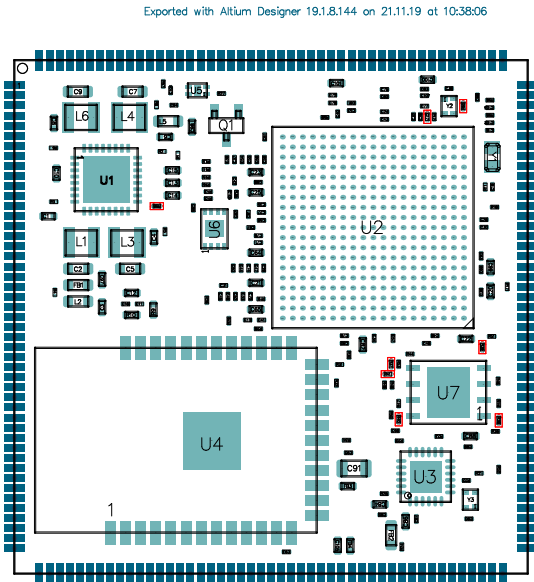

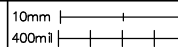


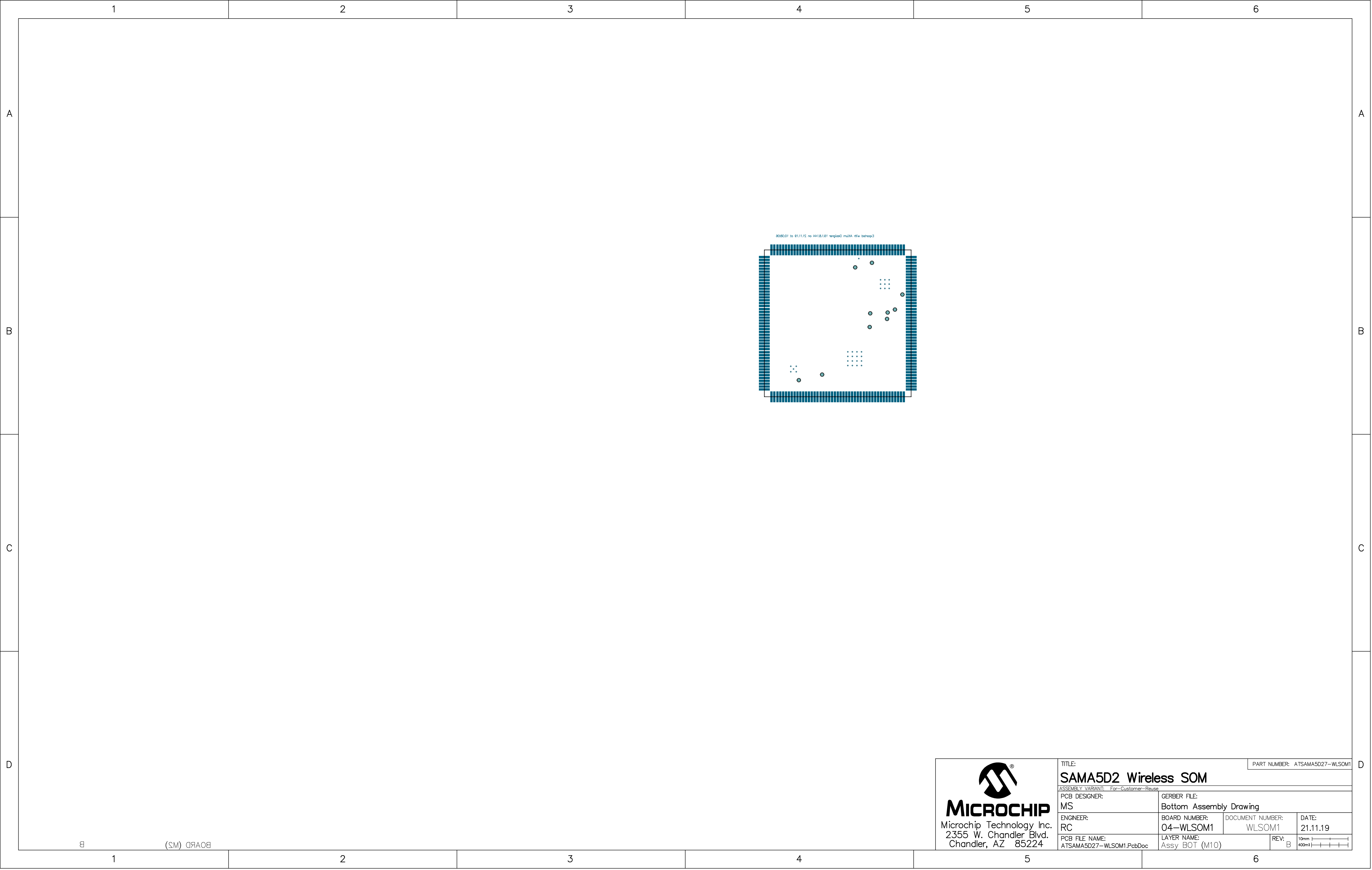
REV	ECO	Comments	Date




ASSEMBLY NOTES:

1. ALL COMPONENTS SHALL BE RoHS COMPLIANT.
2. ALL UNUSED THROUGH HOLE COMPONENT LOCATIONS SHALL BE FREE OF SOLDER.
3. ALL COMPONENTS SHALL BE MOUNTED FLUSH TO THE BOARD, EXCEPT AS NOTED.
4. FINISHED BOARD SHALL BE FREE OF ALL RESIDUES.
5. ALL LEADS SHALL BE TRIMMED TO A MAXIMUM HEIGHT OF 2mm
6. PLACE LABEL ON THE LOCATION INDICATED.
- 7.

 MICROCHIP Microchip Technology Inc. 2355 W. Chandler Blvd. Chandler, AZ 85224	TITLE: SAMA5D2 Wireless SOM			PART NUMBER: ATSAM5D27-WLSOM1	
	ASSEMBLY VARIANT: For-Customer-Reuse				
	PCB DESIGNER: MS		GERBER FILE: Top Assembly Drawing		
	ENGINEER: RC	BOARD NUMBER: WLSOM1		DOCUMENT NUMBER: WLSOM1	DATE: 21.11.19
	PCB FILE NAME: ATSAMA5D27-WLSOM1.PcbDoc		LAYER NAME: BOARD (M11)		REV: B
					



BOARD (S) (M) B



MICROCHIP
Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224

TITLE: SAMA5D2 Wireless SOM				PART NUMBER: ATSAMASD27-WLSOM1	
ASSEMBLY VARIANT: For-Customer-Reuse					
PCB DESIGNER: MS		GERBER FILE: Bottom Assembly Drawing			
ENGINEER: RC		BOARD NUMBER: 04-WLSOM1	DOCUMENT NUMBER: WLSOM1	DATE: 21.11.19	
PCB FILE NAME: ATSAMASD27-WLSOM1.PcbDoc		LAYER NAME: Assy BOT (M10)		REV: B	<div>10mm</div> <div>400mil</div>

